

MAX2650EUS+ Datasheet

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DiGi Electronics Part Number	MAX2650EUS+-DG
Manufacturer	Analog Devices Inc./Maxim Integrated
Manufacturer Product Number	MAX2650EUS+
Description	IC AMP CELL 0HZ-1GHZ SOT143-4
Detailed Description	RF Amplifier IC Cellular, GPS, W-LAN, WLLG 0Hz ~ 1 GHz SOT-143-4

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Manufacturer Product Number:

MAX2650EUS+

Series:

-

Frequency:

0Hz ~ 1GHz

Gain:

21dB

RF Type:

Cellular, GPS, W-LAN, WLLG

Current - Supply:

18mA

Mounting Type:

Surface Mount

Supplier Device Package:

SOT-143-4

Manufacturer:

Analog Devices Inc./Maxim Integrated

Product Status:

Active

P1dB:

-1dBm

Noise Figure:

3.9dB

Voltage - Supply:

4.5V ~ 5.5V

Test Frequency:

900MHz

Package / Case:

TO-253-4, TO-253AA

Base Product Number:

MAX2650

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.33.0001

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



MAX2650

DC-to-Microwave, +5V Low-Noise Amplifier

General Description

The MAX2650 is a low-noise amplifier for use from DC to microwave frequencies. Operating from a single +5V supply, it has a flat gain response to 900MHz. The MAX2650's low noise figure and high drive capability make it ideal for a variety of transmit, receive, and buffer applications.

The device is internally biased, eliminating the need for external bias resistors or inductors. In a typical application, the only external components needed are input and output blocking capacitors and a V_{CC} bypass capacitor.

The MAX2650 comes in a 4-pin SOT143 package, requiring minimal board space.

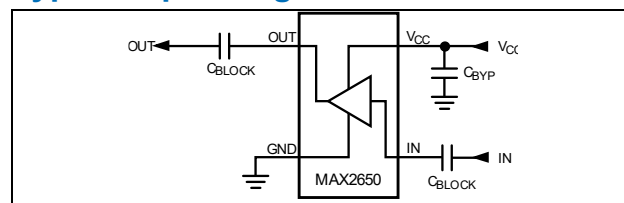
Applications

- Wireless Local Loop
- Global Positioning Systems (GPS)
- ISM Radios
- Special Mobile Radios
- Wireless Local-Area Networks
- Cellular Base Stations
- Set-Top Boxes

Features

- Internally Biased
- High Gain: 18.3dB at 900MHz
- 3.9dB Noise Figure
- Single +4.5V to +5.5V Operation
- -1dBm Output 1dB Compression Power
- Low-Cost Silicon Bipolar Design
- Ultra-Small SOT143 Package

Typical Operating Circuit



Ordering Information appears at end of data sheet.

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Absolute Maximum Ratings

V_{CC} to GND 8V
 Input Power +13dBm
 Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)SOT143-4 (derate 4mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 320mW

Operating Temperature Range -40°C to $+85^\circ\text{C}$
 Junction Temperature $+150^\circ\text{C}$
 Storage Temperature Range -65°C to $+150^\circ\text{C}$
 Lead Temperature (soldering, 10s) $+300^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

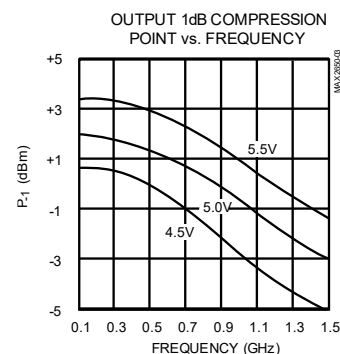
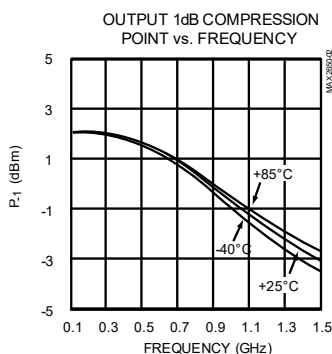
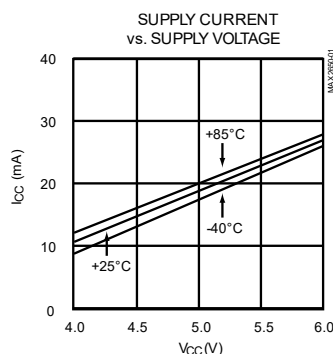
($V_{CC} = +5.0\text{V}$, $Z_0 = 50\Omega$, $f_{IN} = 900\text{MHz}$, $T_A = +25^\circ\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Temperature Range		(Note 1)	-40		85	$^\circ\text{C}$
Power Gain			16.5	18.3	21	dB
Output 1dB Compression Point				-1		dBm
Output IP3				10		dBm
Noise Figure				3.9		dB
Maximum Input Voltage Standing-Wave Ratio		$f_{IN} = 100\text{MHz}$ to 1000MHz		1.5:1		
Maximum Output Voltage Standing-Wave Ratio		$f_{IN} = 800\text{MHz}$ to 1000MHz		1.3:1		
Group Delay				300		ps
Supply Voltage			4.5		5.5	V
Supply Current			15.5	17.7	20.0	mA
		$T_A = T_{MIN}$ to T_{MAX}	13.0	17.7	22.0	
		$V_{CC} = 4.5\text{V}$ to 5.5V	11.0	17.7	24.0	

Note 1: Parts are designed to operate over specified temperature range. Specifications are production tested and guaranteed at $+25^\circ\text{C}$.

Typical Operating Characteristics

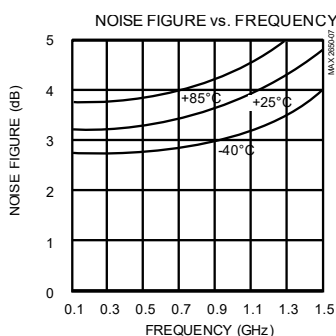
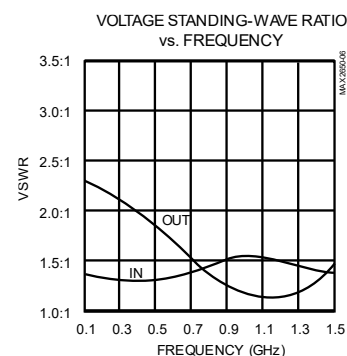
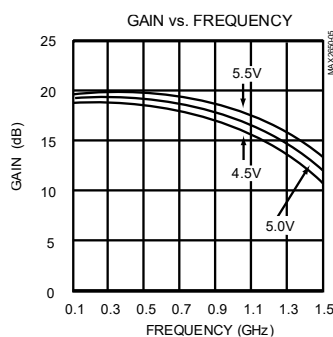
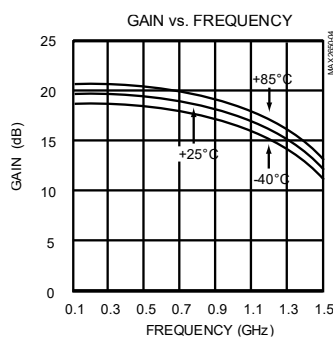
($V_{CC} = 5.0\text{V}$, $Z_0 = 50\Omega$, $f_{IN} = 900\text{MHz}$, $T_A = +25^\circ\text{C}$, unless otherwise noted.)



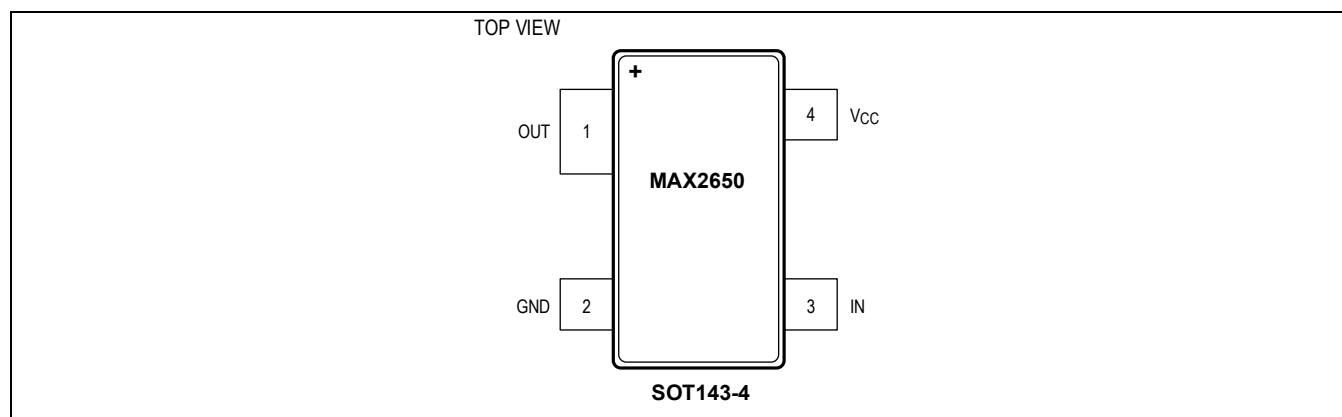
DC-to-Microwave, +5V Low-Noise Amplifier

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($V_{CC} = 5.0V$, $Z_0 = 50\Omega$, $f_{IN} = 900MHz$, $T_A = +25^\circ C$, unless otherwise noted.)



Pin Configurations



Pin Descriptions

PIN	NAME	FUNCTION
1	OUT	Amplifier Output. Use a series blocking capacitor with less than 3Ω reactance at your lowest operating frequency.
2	GND	Ground Connection. For optimum performance, provide a low-inductance connection to the ground plane.
3	IN	Amplifier Input. Use a series blocking capacitor with less than 3Ω reactance at your lowest operating frequency.

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4	V _{CC}	Supply Connection. Bypass directly at the package pin. The value of the bypass capacitor is determined by the lowest operating frequency and is typically the same as the blocking capacitor value. For long V _{CC} lines, additional bypassing may be necessary.
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Detailed Description

The MAX2650 is a broadband amplifier with flat gain and 50Ω input and output ports. Its small size and internal bias circuitry make it ideal for applications where board space is limited.

Table 1. Typical Scattering Parameters

(V_{CC} = +5V, Z₀ = 50Ω, T_A = +25°C.)

FREQUENCY (GHz)	S11 (mag)	S11 (ang)	S21 (dB)	S21 (mag)	S21 (ang)	S12 (dB)	S12 (mag)	S12 (ang)	S22 (mag)	S22 (ang)	K
0.05	0.17	-3	19.8	9.76	177	-37.8	0.013	8	0.42	-5	3.18
0.10	0.17	-6	19.8	9.72	172	-36.7	0.015	14	0.39	-6	2.92
0.20	0.16	9	19.7	9.69	161	-35.8	0.016	23	0.37	-13	2.70
0.30	0.14	8	19.7	9.70	151	-35.0	0.018	28	0.35	-19	2.54
0.40	0.16	0	19.6	9.52	140	-33.8	0.020	32	0.32	-26	2.31
0.50	0.16	-7	19.5	9.43	129	-33.2	0.022	34	0.28	-34	2.24
0.60	0.17	-17	19.3	9.21	119	-32.3	0.024	37	0.25	-43	2.12
0.70	0.18	-26	19.0	8.93	107	-31.7	0.026	41	0.21	-53	2.09
0.80	0.18	-39	18.6	8.46	95	-31.1	0.028	44	0.17	-62	2.10
0.90	0.20	-54	18.0	7.92	84	-29.5	0.033	48	0.13	-71	1.91
1.00	0.20	-66	17.4	7.40	73	-28.7	0.037	50	0.10	-76	1.88
1.20	0.19	-86	15.7	6.10	51	-26.9	0.045	52	0.05	-49	1.88
1.40	0.16	-86	13.4	4.69	31	-25.5	0.053	51	0.12	-12	2.03
1.60	0.15	-66	10.6	3.40	14	-24.4	0.060	44	0.24	-17	2.32
1.80	0.22	-40	7.4	2.35	5	-24.4	0.060	32	0.35	-27	3.01
2.00	0.33	-36	4.6	1.70	4	-25.3	0.055	22	0.43	-33	3.97
2.20	0.41	-38	3.1	1.43	6	-26.5	0.047	21	0.46	-33	4.85
2.40	0.44	-37	2.5	1.34	6	-28.6	0.037	22	0.49	-29	6.26
2.50	0.44	-37	2.3	1.30	4	-29.5	0.034	22	0.49	-25	7.05

Applications Information

External Components

As shown in the Typical Operating Circuit, the MAX2650 is easy to use. Input and output series capacitors may be necessary to block DC bias voltages (generated by the MAX2650) from interacting with adjacent circuitry. These capacitors must be large enough to contribute negligible reactance in a 50Ω system at the minimum operating frequency. Use the following equation to calculate their minimum value:

$$C_{BLOCK} = \frac{53000}{f} \text{ (pF)}$$

where f (in MHz) is the minimum operating frequency.

The V_{CC} pin must be RF bypassed for correct operation. To accomplish this, connect a capacitor between the V_{CC} pin and ground, as close to the package as is practical. Use the same equation given above (for DC blocking capacitor values)

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to calculate the minimum capacitor value. If there are long V_{CC} lines on the PC board, additional bypassing may be necessary. This may be done further away from the package, at your discretion.

Proper grounding of the GND pin is essential. If the PC board uses a topside RF ground, the GND pin should connect directly to it. For a board where the ground plane is not on the component side, the best technique is to connect the GND pin to it through multiple plated through-holes.

PC Board Layout Example

An example PC board layout is given in Figure 1. It uses FR-4 with 31mil layer thickness between the RF lines and the ground plane. The board satisfies all the above requirements.

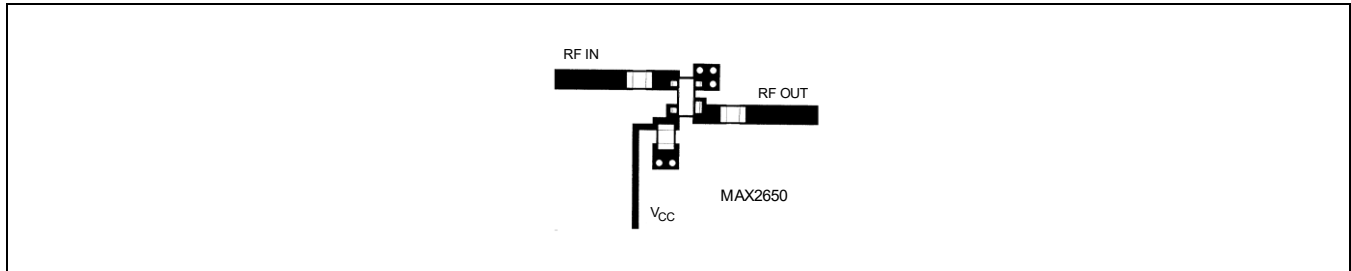
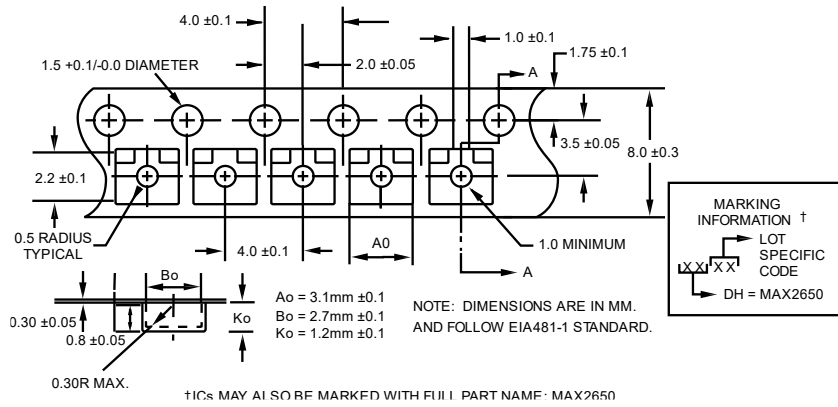


Figure 1. Example PC Board Layout

DC-to-Microwave, +5V Low-Noise Amplifier

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Tape-and-Reel/Marking Information



Package Information

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.031	0.047	0.787	1.194
A1	0.001	0.005	0.025	0.127
B	0.014	0.022	0.356	0.559
B1	0.030	0.038	0.762	0.965
C	0.0034	0.006	0.086	0.152
D	0.105	0.120	2.667	3.048
E	0.047	0.055	1.194	1.397
e	0.070	0.080	1.778	2.032
e1	0.071	0.079	1.803	2.007
H	0.082	0.098	2.083	2.489
I	0.004	0.012	0.102	0.305

21-0052A

4-PIN SOT143-4
SMALL-OUTLINE
TRANSISTOR PACKAGE

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.analog.com/packages.)

Ordering Information

PART NUMBER	TEMP RANGE	PIN-PACKAGE
MAX2650EUS-T	-40°C to +85°C	4 SOT143-4

DC-to-Microwave, +5V Low-Noise Amplifier

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	4/24	Updated formatting, Pin Configuration and Pin Description	4



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